

N-Channel 600V (D-S) Super Junction Power MOSFET With Fast Diode

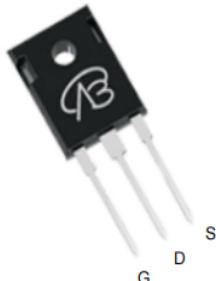
PRODUCT SUMMARY		
V _{DS} (V) at T _J max.	650	
R _{DS(on)} at 25 °C (Ω)	V _{GS} = 10 V	0.068

FEATURES

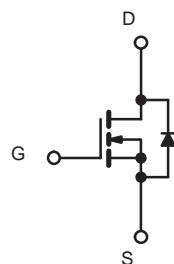
- Low figure-of-merit (FOM) R_{on} x Q_g
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)



TO-247



Top View



N-Channel MOSFET

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{GS} at 10 V	V _{DS}	650	V
Gate-Source Voltage		V _{GS}	± 30	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C T _C = 100 °C	I _D	36	A
			22	
Pulsed Drain Current ^a	I _{DM}		108	
Linear Derating Factor			1.67	W/°C
Single Pulse Avalanche Energy ^b	E _{AS}		1400	mJ
Maximum Power Dissipation	P _D		210	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}		-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		50 15	V/ns
Reverse Diode dV/dt ^d				
Soldering Recommendations (Peak Temperature) ^c	for 10 s		260	°C

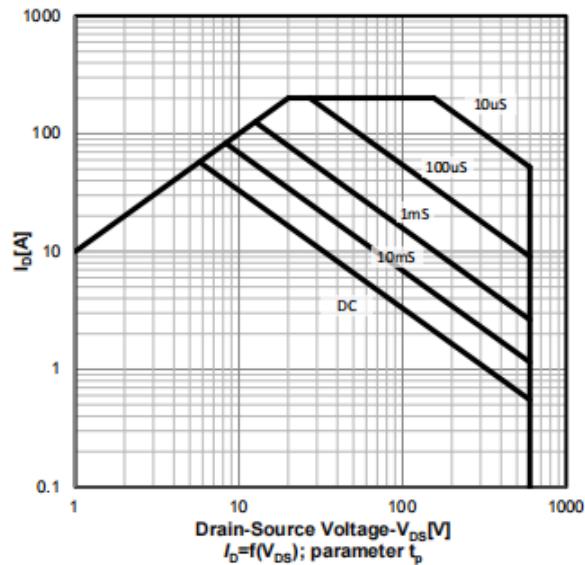
Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- V_{DD} = 100 V, starting T_J = 25 °C, L = 30mH, R_g = 25 Ω, I_{AS} = 13A.
- 1.6 mm from case.
- I_{SD} ≤ I_D, dI/dt = 100 A/μs, starting T_J = 25 °C.

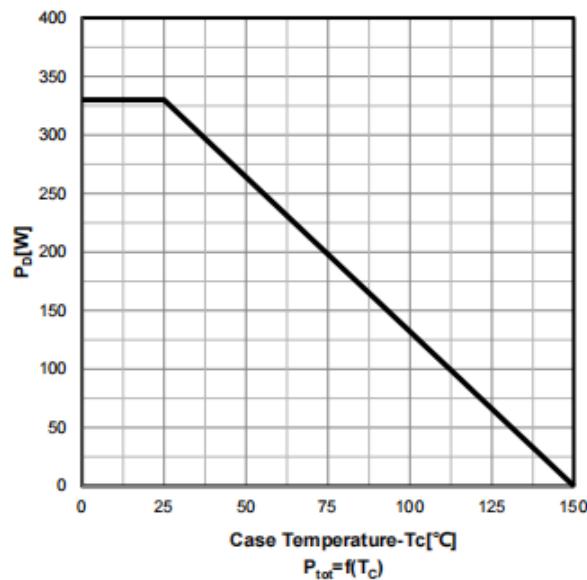
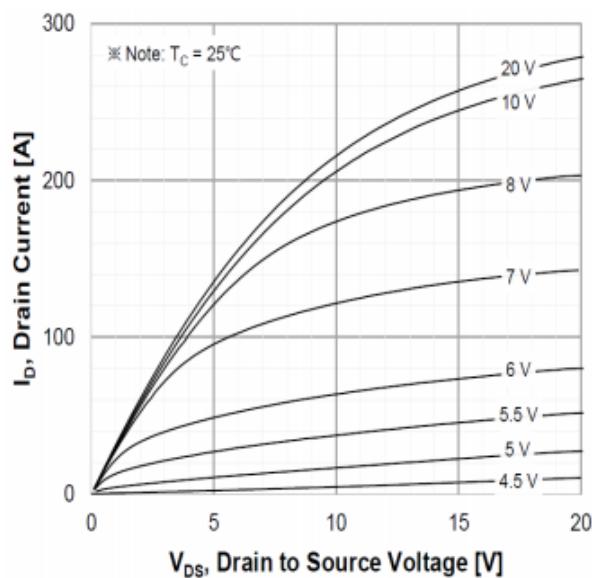
THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R_{thJA}	-	62	$^{\circ}\text{C}/\text{W}$		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.38			
SPECIFICATIONS ($T_J = 25^{\circ}\text{C}$, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$, $I_D = 1 \text{ mA}$		650	-	-
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25°C , $I_D = 1 \text{ mA}$		-	0.70	-
Gate-Source Threshold Voltage (N)	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$		2.5	-	4.5
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100
		$V_{GS} = \pm 30 \text{ V}$		-	-	± 1
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 650 \text{ V}$, $V_{GS} = 0 \text{ V}$		-	-	1
		$V_{DS} = 520 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 125^{\circ}\text{C}$		-	-	100
Drain-Source On-State Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}$	$I_D = 12 \text{ A}$	-	0.068	-
Forward Transconductance	g_{fs}	$V_{DS} = 30 \text{ V}$, $I_D = 12 \text{ A}$		-	5.6	-
Dynamic						
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}$, $V_{DS} = 100 \text{ V}$, $f = 1 \text{ MHz}$		-	5200	-
Output Capacitance	C_{oss}			-	330	-
Reverse Transfer Capacitance	C_{rss}			-	4	-
Effective Output Capacitance, Energy Related ^a	$C_{o(er)}$			-	63	-
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$	$V_{DS} = 0 \text{ V to } 520 \text{ V}$, $V_{GS} = 0 \text{ V}$		-	213	-
Total Gate Charge	Q_g			-	60	-
Gate-Source Charge	Q_{gs}			-	39	-
Gate-Drain Charge	Q_{gd}			-	4.7	-
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 520 \text{ V}$, $I_D = 20 \text{ A}$, $V_{DS} = 520 \text{ V}$		-	18	25
Rise Time	t_r			-	24	55
Turn-Off Delay Time	$t_{d(off)}$			-	8.0	-
Fall Time	t_f			-	1.2	-
Gate Input Resistance	R_g	$f = 1 \text{ MHz}$, open drain		-	0.8	-
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	36
Pulsed Diode Forward Current	I_{SM}			-	-	108
Diode Forward Voltage	V_{SD}	$T_J = 25^{\circ}\text{C}$, $I_S = 8 \text{ A}$, $V_{GS} = 0 \text{ V}$		-	-	1.5
Reverse Recovery Time	t_{rr}	$T_J = 25^{\circ}\text{C}$, $I_F = I_S = 8 \text{ A}$, $dl/dt = 100 \text{ A}/\mu\text{s}$, $V_R = 400 \text{ V}$		-	80	-
Reverse Recovery Charge	Q_{rr}			-	5.8	-
Reverse Recovery Current	I_{RRM}			-	45	-

Notes

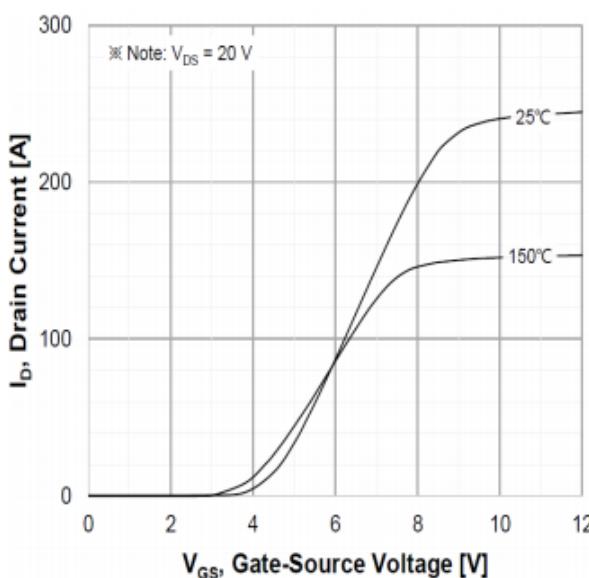
a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
 b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

Safe operating area $T_C=25\text{ }^\circ\text{C}$
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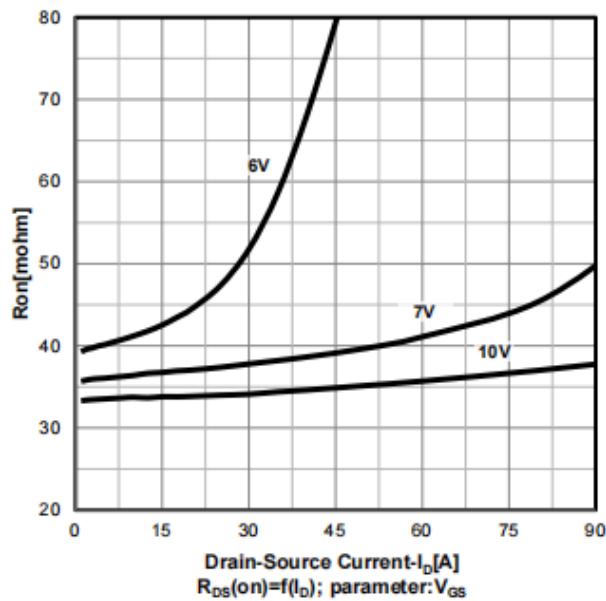
Power dissipation

Typ. output characteristics $T_J=25\text{ }^\circ\text{C}$ 

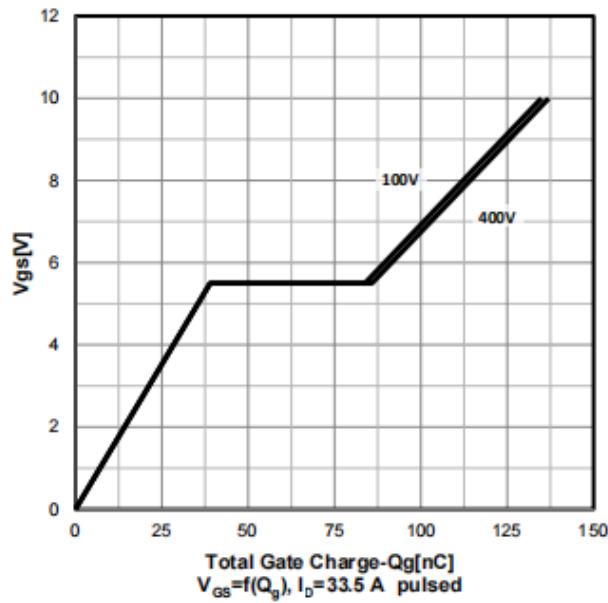
Transfer characteristics



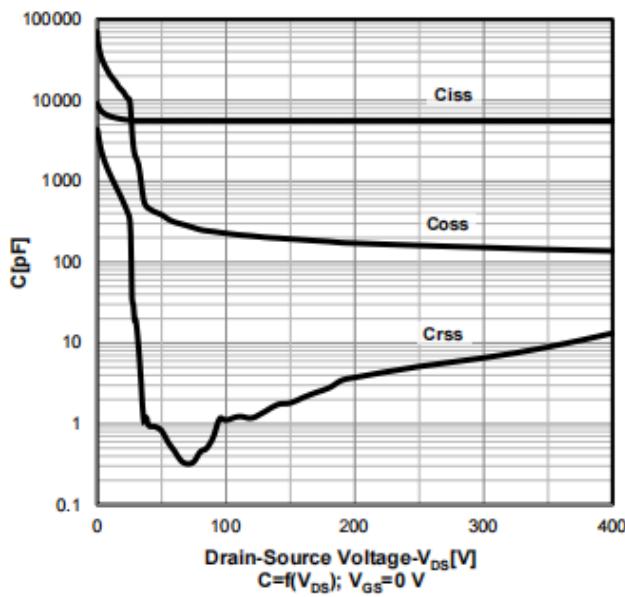
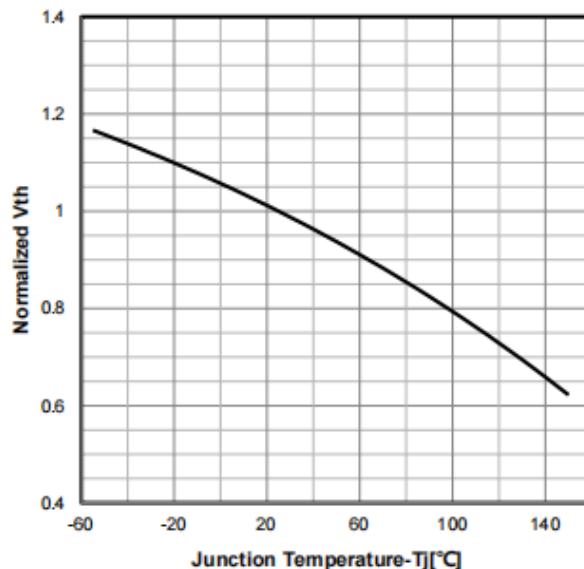
Typ. drain-source on-state resistance



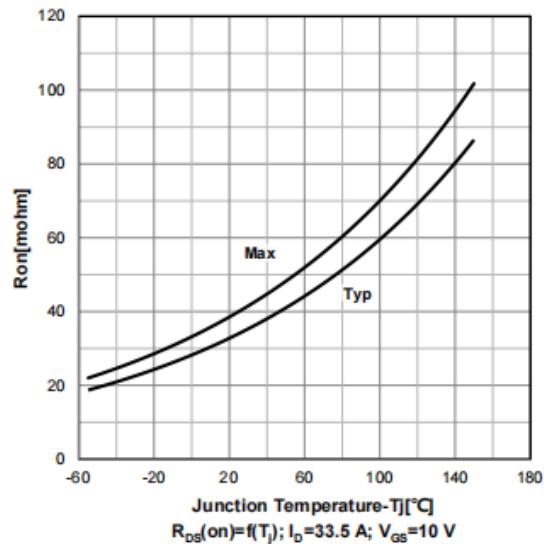
Typ. gate charge characteristics



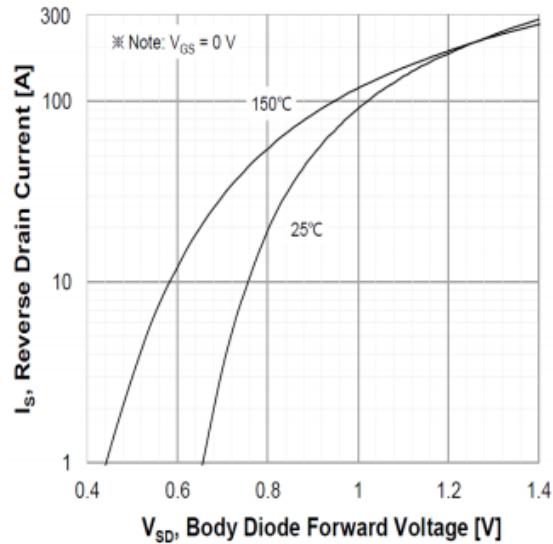
Typ. capacitances

Normalized $V_{GS(th)}$ characteristics

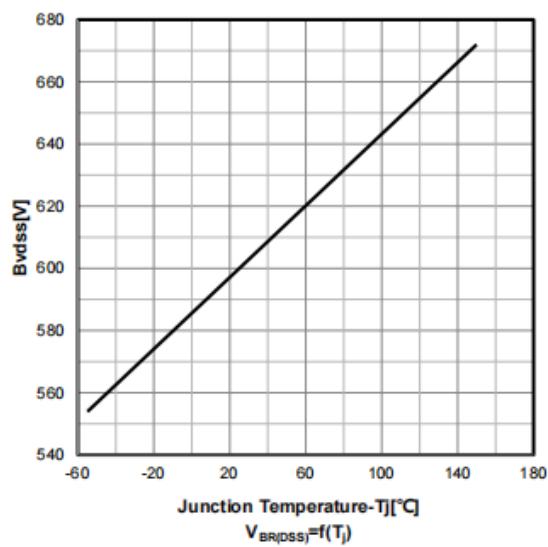
On-resistance vs temperature



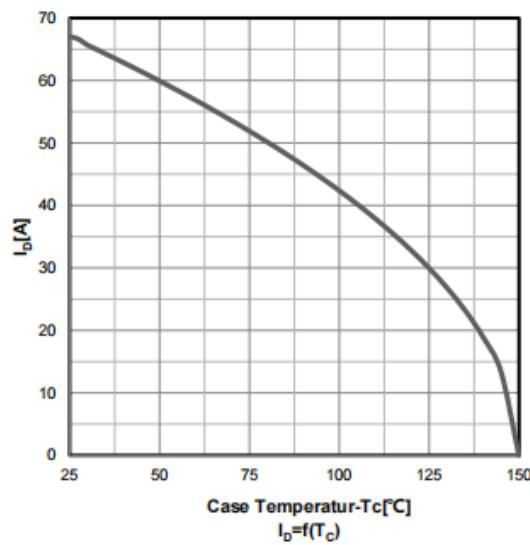
Forward characteristics of reverse diode



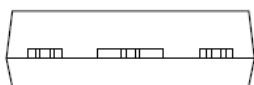
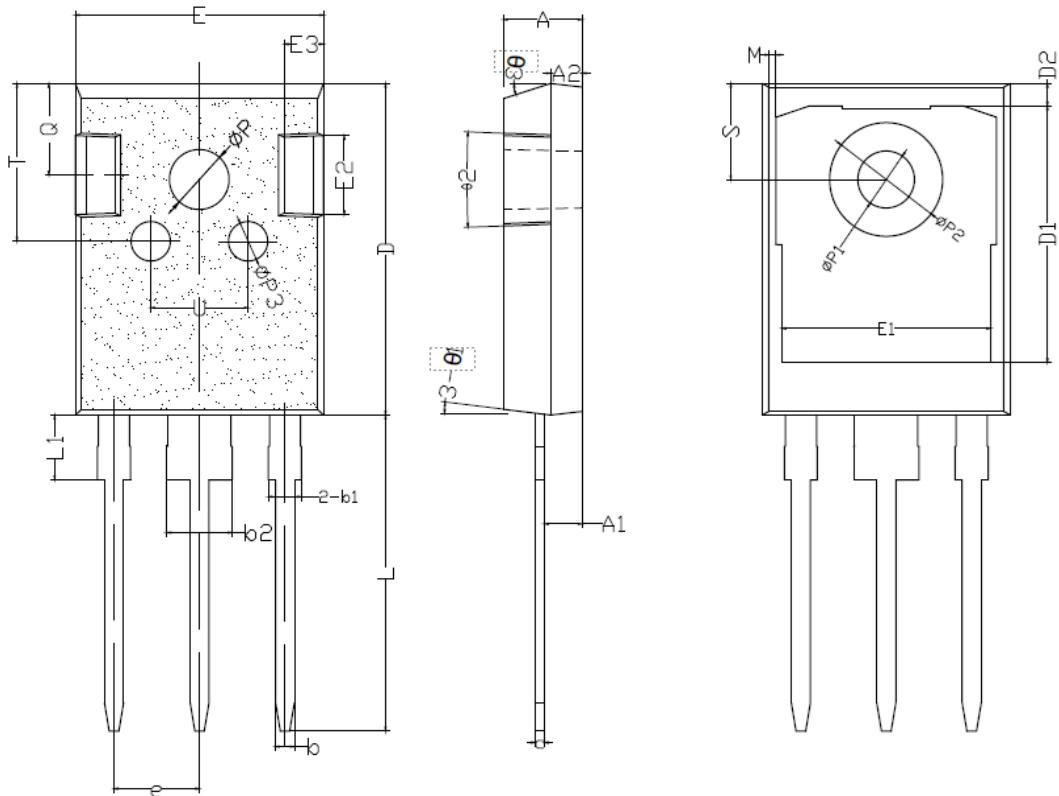
Drain-source breakdown voltage



Drain current vs temperature



TO-247 PACKAGE OUTLINE DIMENSIONS



SYMBOL	mm		
	MIN	NOM	MAX
*A	4.90	5.00	5.10
*A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
*b	1.15	1.20	1.25
*b1	1.95	2.10	2.25
*b2	2.95	3.10	3.25
*c	0.55	0.60	0.65
*D	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35

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